



Product Change Notification

106127 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 106127 - 01
Change Title: SC5300, PCN 106127-01, Product Marking, CLASS 2, MEMORY BAFFLE REQUIRES TEXT CHANGES TO BECOME UNIVERSAL PART, Reason for Revision: Update TA numbers
Date of Publication: July 11, 2006

Key Characteristics of the Change:

Product Marking

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jul 14, 2006
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Description of Change to the Customer:

Reason for Revision: Update TA numbers

Replace current wording on air baffle from specific board family designators to generic board footprint size. See new wording below.
New wording- "MEMORY BAFFLE - REMOVE FOR SERVER BOARDS 10.5" X 12" OR SMALLER"

Customer Impact of Change and Recommended Action:

Intel anticipates no impact

Products Affected / Intel Ordering Codes:

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA	Post-Change TA	Pre-Change Subassembly	Post-Change Subassembly
SC5300AF2	880711	880711	D50256-001	D50256-002		
SC5300AF2NA	881230	881230	D50256-001	D50256-002		
SC5300BASE	880708	880708	D50255-002	D50255-003		
SC5300BASENA	881225	881225	D50255-002	D50255-003		
SC5300BRP	880707	880707	D50251-002	D50251-003		
SC5300BRPNA	881223	881223	D50251-002	D50251-003		
SC5300LX	880072	880072	D50258-002	D50258-003		
SC5300LXNA	881228	881228	D50258-002	D50258-003		

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

May 24, 2006

00

Originally Published PCN

July 11, 2006

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Update TA numbers